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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/622,484	07/21/2003	Michael Setton	015290-755	4980	
7590 09/30/2005			EXAMINER		
Peter K. Skiff			POMPEY, RON EVERETT		
BURNS, DOANE, SWECKER & MATHIS, L.L.P.				D + DDD > W   / DDD	
P.O. Box 1404			ART UNIT	PAPER NUMBER	
Alexandria, VA 22313-1404			2812		

DATE MAILED: 09/30/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

•		Application	on No.	Applicant(s)			
		10/622,48	34	SETTON, MICH,	SETTON, MICHAEL		
	Office Action Summary	Examiner		Art Unit			
		Ron E. Po	mpey	2812			
Period fo	The MAILING DATE of this communication or Reply	n appears on the	cover sheet w	vith the correspondence a	ddress		
WHIC - Exte after - If NC - Failu Any	ORTENED STATUTORY PERIOD FOR R CHEVER IS LONGER, FROM THE MAILIN nsions of time may be available under the provisions of 37 CI SIX (6) MONTHS from the mailing date of this communicatic p period for reply is specified above, the maximum statutory p ire to reply within the set or extended period for reply will, by a reply received by the Office later than three months after the ed patent term adjustment. See 37 CFR 1.704(b).	IG DATE OF THE FR 1.136(a). In no evo on. period will apply and wi statute, cause the app	IIS COMMUNI ent, however, may a III expire SIX (6) MO lication to become A	ICATION. reply be timely filed  NTHS from the mailing date of this BANDONED (35 U.S.C. § 133).			
Status							
1) 🖂	Responsive to communication(s) filed on	06 Sentember 2	2005				
′ =	· · · · · · · · · · · · · · · · · · ·	This action is n					
3)	/ <del></del>						
٥/١	closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
Dispositi	ion of Claims	•	,	·			
-		n the application	n				
7)63	Claim(s) <u>38-47 and 49-52</u> is/are pending in the application.						
5\ <b>X</b>	4a) Of the above claim(s) is/are withdrawn from consideration.						
	Claim(s) <u>40-43</u> is/are allowed.						
	Claim(s) <u>39-39 and 44-52</u> is/are rejected.						
7)[	Claim(s) is/are objected to.						
8)	Claim(s) are subject to restriction a	ind/or election r	equirement.				
Applicat	ion Papers						
9) 🗌	The specification is objected to by the Exa	miner.					
10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.							
	Applicant may not request that any objection to	o the drawing(s) b	e held in abeya	nce. See 37 CFR 1.85(a).			
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).							
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.							
Priority ι	under 35 U.S.C. § 119						
-	12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) All b) Some * c) None of:  1. Certified copies of the priority documents have been received.  2. Certified copies of the priority documents have been received in Application No.						
	3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).						
* (	See the attached detailed Office action for a	a list of the certi	fied copies no	t received.			
Attachmen	t(s)						
1) 🔲 Notic	e of References Cited (PTO-892)			Summary (PTO-413)			
3) 🔲 Infor	e of Draftsperson's Patent Drawing Review (PTO-94) mation Disclosure Statement(s) (PTO-1449 or PTO/S r No(s)/Mail Date	•		(s)/Mail Date Informal Patent Application (PT 	ГО-152)		

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## **DETAILED ACTION**

## Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 38-39 and 44-52 are rejected under 35 U.S.C. 103(a) as being unpatentable over Pfiester (US 5,200,352) in view of Wu (5,880,508) in further view of admitted prior art or Ohiwa et al. (4,947,081).

Pfiester discloses the limitations of:

forming an interfacial layer (14, fig. 1A), comprising silicon nitride or silicon oxynitride, on a silicon semiconductor substrate; and

forming a gate electrode of an electrically conductive material on the interfacial layer:

source and drain regions (32, fig. 1E) that are adjacent the gate electrode(col. 2, ln. 48 – col. 4, ln. 33); and

forming spacer (20, fig. 1A) adjacent to the gate electrode and on an upper surface of the interfacial layer (col. 5, Ins. 30-41).

3. Pfiester reads on the claims as applied above, but does not disclose the claimed limitation(s) below of:

forming a high dielectric constant layer (8, fig. 1) on the interfacial layer;

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forming a high dielectric constant layer (2, fig. 5a) on the interfacial layer, the comprises a material that is selected from the group consisting of  $Ta_2O_5$ ,  $Ta_2(O_{1-x}N_x)_5$  wherein x ranges from greater than 0 to 0.6, a solid solution of  $(Ta_2O_5)_t$  -  $(ZrO_2)_{1-t}$  wherein t ranges from about 0.9 to less than 1, and a solid solution of  $(Ta_2O_5)_u$ - $(HfO_2)_{1-u}$  wherein u ranges from about 0.9 to less than 1 and a solid solution  $(Ta_2O_5)_s$ - $(Al_2O_3)_{1-s}$  wherein s ranges from 0.9 to less than 1 wherein the interfacial layer separates the high dielectric constant layer from the substrate;:

having a gate width of less than 0.3 micron covering the high dielectric constant layer; and

wherein the interfacial layer and the high dielectric constant layer separates the spacers from the substrate.

However,

a. Wu discloses the above claimed limitations regarding:

forming a high dielectric constant layer (8, fig. 1) on the interfacial layer (6, fig. 1), the comprises a material that is selected from the group consisting of  $Ta_2O_5$ , wherein the interfacial layer comprises silicon nitride or silicon oxynitride;

wherein the interfacial layer separates the high dielectric constant layer from the substrate; and

having a gate width of less than 0.3 micron covering the high dielectric constant layer (column 1, ln. 25).

Therefore, it would have been obvious to one of ordinary skill in the art at the time of the invention to combine Pfiester with Wu, because the high dielectric constant

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layer provides for a gate insulator layer that reduces hot carrier effect; and the gate width of less than 0.3 micron take up less wafer real estate, which means more devices can be formed on one wafer. Note: that because the spacers are formed after the gate oxide in Pfiester the spacers would also be formed on the high dielectric layer when combining Wu with Pfiester.

b. Pfiester and Wu, fail to disclose the limitations of:

wherein the high dielectric layer comprises one of the following,  $Ta_2 (O_{1-x} N_x)_5$  wherein x ranges from greater than 0 to 0.6. However the admitted prior art, on page 6, line 24 –26, or Ohiwa, column 2, lines 45-58, discloses that a high dielectric layer can be formed of the above compositions. Also, Ohiwa discloses that tantalum oxynitride in the claimed range is art recognized equivalent to tantalum pentoxide.

Also, in applicants' specification, page 7, line 25 – page 8, line 3, states that it is conventional for photoresist/lithography techniques to form a gate pattern that will form the line width of a gate less than 0.3 micron.

Therefore it would have been obvious to one of ordinary skill in the art to combine the admitted prior art (APA) and/or Ohiwa with Wu, because the above listed materials are art equivalent high dielectric material with Ta<sub>2</sub>O<sub>5</sub> of the Wu reference.

## Allowable Subject Matter

- 4. Claims 40-43 are allowed.
- 5. The following is a statement of reasons for the indication of allowable subject matter: the prior art of record, either singly or in combination, fails to disclose the limitations of: wherein the high dielectric layer comprises one of the following

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compositions, a solid solution of  $(Ta_2O_5)_t - (ZrO_2)_{1-t}$ , and a solid solution of  $(Ta_2O_5)_u - (HfO_2)_{1-u}$  wherein t and u range from about .09 to less than 1.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Ron E. Pompey whose telephone number is (571) 272-1680. The examiner can normally be reached on compressed.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael S. Lebentritt can be reached on (571) 272-1873. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Ron Pompey

AU: 2812

September 19, 2005

MICHAEL LEBENTHIT